VS-42CTQ030SHM3, VS-42CTQ030-1HM3

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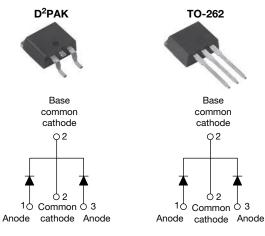
RoHS

COMPLIANT

HALOGEN

FREE

High Performance Schottky Rectifier, 2 x 20 A



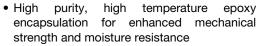
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VS-4	12C I	I WU	305	НМ3	

VS-42CTQ030-1HM3

PRODUCT SUMMARY						
I _{F(AV)}	2 x 20 A					
V_R	30 V					
V _F at I _F	0.38 V					
I _{RM}	183 mA at 125 °C					
T _J max.	150 °C					
E _{AS}	13 mJ					
Package	TO-263AB (D ² PAK), TO-262AA					
Diode variation	Common cathode					

FEATURES

- 150 °C T_J operation
- Center tap configuration
- · Very low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability





- AEC-Q101 qualified meets JESD 201 class 1A whisker test
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

This center tap Schottky rectifier module has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL CHARACTERISTICS VALUES UNITS								
I _{F(AV)}	Rectangular waveform	40	А					
V _{RRM}		30	V					
I _{FSM}	t _p = 5 μs sine	1100	Α					
V _F	20 A _{pk} , T _J = 125 °C (per leg)	0.38	V					
TJ	Range	-55 to 150	°C					

VOLTAGE RATINGS							
PARAMETER SYMBOL VS-42CTQ030SHM3 VS-42CTQ030-1HM3 UNITS							
Maximum DC reverse voltage	V_{R}	30	V				
Maximum working peak reverse voltage	V_{RWM}	30	V				



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ABSOLUTE MAXIMUM RATINGS								
PARAMETER		SYMBOL	TEST COND	VALUES	UNITS			
Maximum average forward current	per leg	I=	50 % duty cycle at T _C = 121 °C, rectangular waveform		20			
See fig. 5	per device	I _{F(AV)}	30 % duty cycle at 10 = 121 V	40	Α			
	Maximum peak one cycle non-repetitive		5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated		1100		
surge current per leg See fig. 7		I _{FSM}	10 ms sine or 6 ms rect. pulse	V _{RRM} applied		360		
Non-repetitive avalanche energy per leg		E _{AS}	T _J = 25 °C, I _{AS} = 3 A, L = 2.90 mH		13	mJ		
Repetitive avalanche current per leg		I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		3	Α		

ELECTRICAL SPECIFICATION	S				
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS	
		20 A	- T _{.1} = 25 °C	0.48	V
Maximum forward voltage drop per leg	V _{FM} ⁽¹⁾	40 A	- IJ=25 C	0.57	
See fig. 1	V FM (1)	20 A	- T _{.1} = 125 °C	0.38	
		40 A	- IJ = 125 C	0.51	
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	V - Potod V	3	mA
See fig. 2	'RM \''	T _J = 125 °C	V _R = Rated V _R	183	
Threshold Voltage	V _{F(TO)}	T _{.I} =T _{.I} maximum		0.22	V
Forward slope resistance	r _t	I J = I J III axii II u III		6.76	mΩ
Maximum junction capacitance per leg	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz), 25 °C		2840	pF
Typical series inductance per leg	L _S	Measured lead to lead 5 mm from package body		8.0	nΗ
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs

Note

 $^{^{(1)}\,}$ Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum junction and storage temperature range	ge	T _J , T _{Stg}		-55 to 150	°C			
Maximum thermal resistance junction to case per leg	,	D	DC operation	2.0				
Maximum thermal resistance, junction to case per package		R_{thJC}	DC Operation	1.0	°C/W			
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50				
Approximate weight				2	g			
Approximate weight				0.07	oz.			
Mounting torque	minimum			6 (5)	kgf · cm			
Mounting torque -	maximum			12 (10)	(lbf \cdot in)			
Madiana			Case style D ² PAK	42CTQ	030SH			
Marking device			Case style TO-262	42CTQ030-1H				



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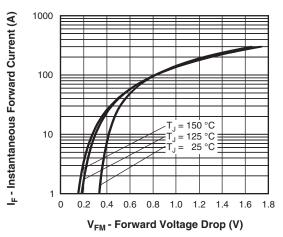


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

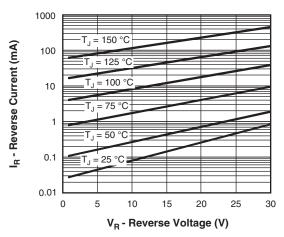


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

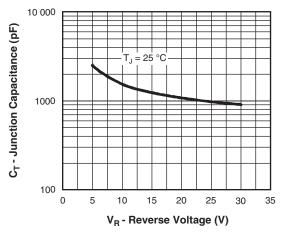


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

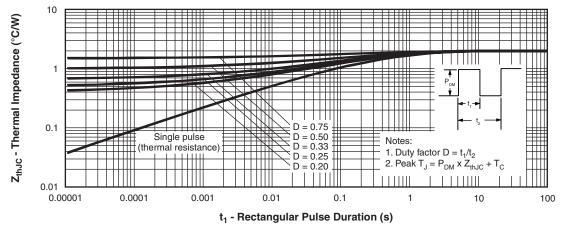


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

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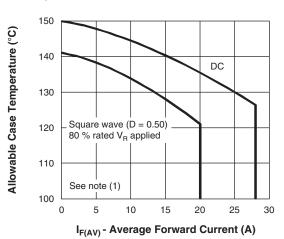


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

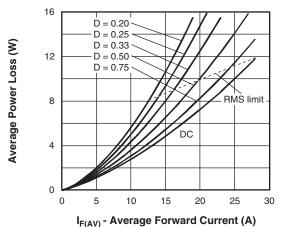


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

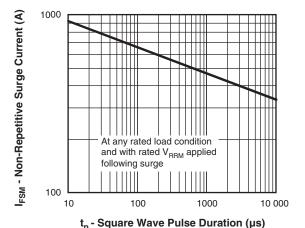


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

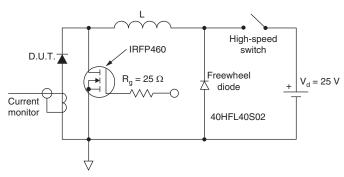


Fig. 8 - Unclamped Inductive Test Circuit

Note

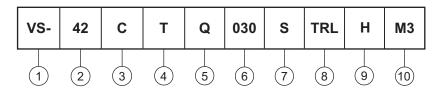
 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \text{Forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{Inverse power loss} = V_{R1} \times I_R \text{ (1 - D); } I_R \text{ at } V_{R1} = 10 \text{ V}. \end{array}$

VS-42CTQ030SHM3, VS-42CTQ030-1HM3

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (40 A)

- Circuit configuration: C = Common cathode

4 - T = TO-220

5 - Schottky "Q" series

Voltage rating (030 = 30 V)

7 - • S = D²PAK

• -1 = TO-262

8 - • None = Tube

• TRL = Tape and reel (left oriented - for D²PAK only)

• TRR = Tape and reel (right oriented - for D²PAK only)

9 - H = AEC-Q101 qualified

- M3 = Halogen-free, RoHS-compliant and termination lead (Pb)-free

ORDERING INFORMATION							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-42CTQ030SHM3	50	1000	Antistatic plastic tubes				
VS-42CTQ030STRRHM3	800	800	13" diameter reel				
VS-42CTQ030STRLHM3	800	800	13" diameter reel				
VS-42CTQ030-1HM3	50	1000	Antistatic plastic tubes				

LINKS TO RELATED DOCUMENTS						
Dimensions —	TO-263AB (D ² PAK)	www.vishay.com/doc?95046				
Dimensions -	TO-262AA	www.vishay.com/doc?95419				
Dort marking information	TO-263AB (D ² PAK)	www.vishay.com/doc?95444				
Part marking information -	TO-262AA	www.vishay.com/doc?95443				
Packaging information		www.vishay.com/doc?95032				



Vishay Semiconductors

D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL -	NOTES SYN		MILLIM	ETERS	INC	HES	NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES	STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES		
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3	
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3	
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3	
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100) BSC		
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625		
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110		
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3	
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070		
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC		
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208		

Notes

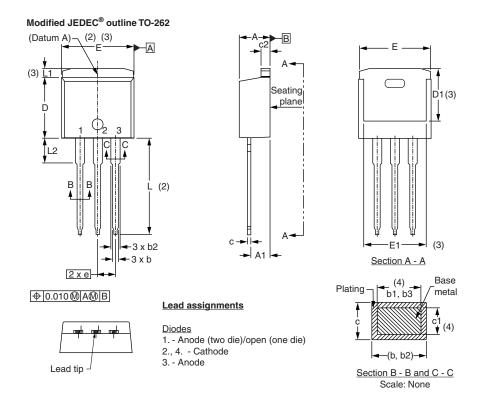
- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB



Vishay Semiconductors

TO-262

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	IETERS	INC	INCHES		
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.06	4.83	0.160	0.190		
A1	2.03	3.02	0.080	0.119		
b	0.51	0.99	0.020	0.039		
b1	0.51	0.89	0.020	0.035	4	
b2	1.14	1.78	0.045	0.070		
b3	1.14	1.73	0.045	0.068	4	
С	0.38	0.74	0.015	0.029		
c1	0.38	0.58	0.015	0.023	4	
c2	1.14	1.65	0.045	0.065		
D	8.51	9.65	0.335	0.380	2	
D1	6.86	8.00	0.270	0.315	3	
E	9.65	10.67	0.380	0.420	2, 3	
E1	7.90	8.80	0.311	0.346	3	
е	2.54	BSC	0.10	D BSC		
L	13.46	14.10	0.530	0.555		
L1	-	1.65	-	0.065	3	
L2	3.36	3.71	0.132	0.146		

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum), D1 (minimum) and L2 where dimensions derived the actual package outline

Revision: 11-Jul-2019 1 Document Number: 95419



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